9.9. SETUP PHOTOS

Radiated Emission photos.





Page 41 of 82

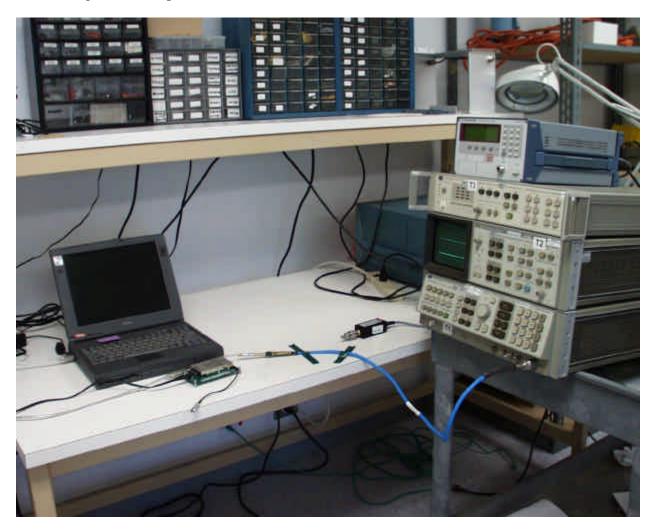
Conducted Emission Photos





Page 42 of 82

FCC testing to antenna port



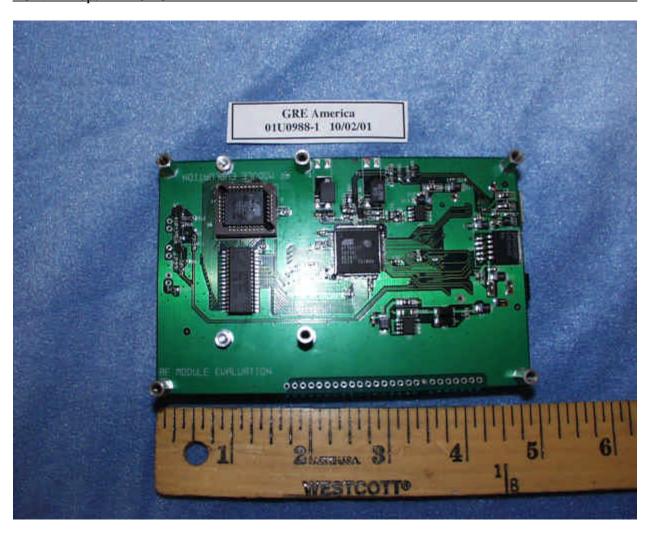
FCC testing above 1GIGHz

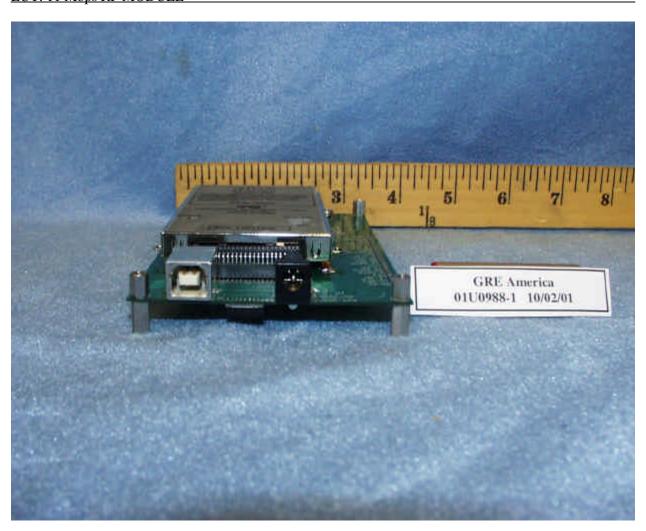


ATTACHMENTS

EUT PHOTOGRAPHS







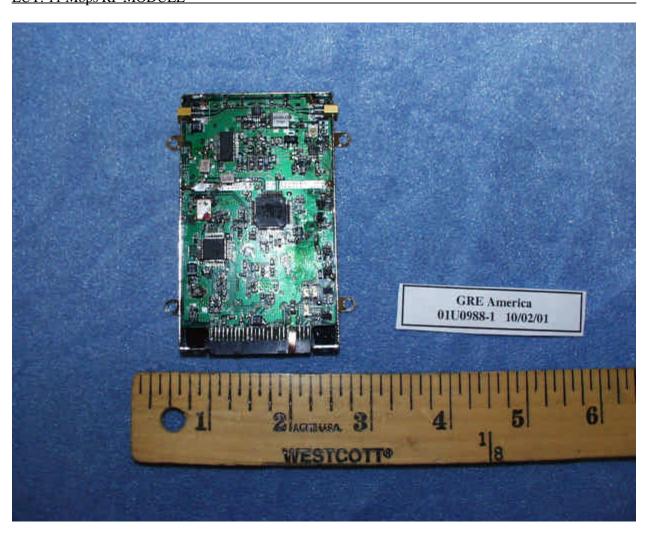






Page 51 of 82





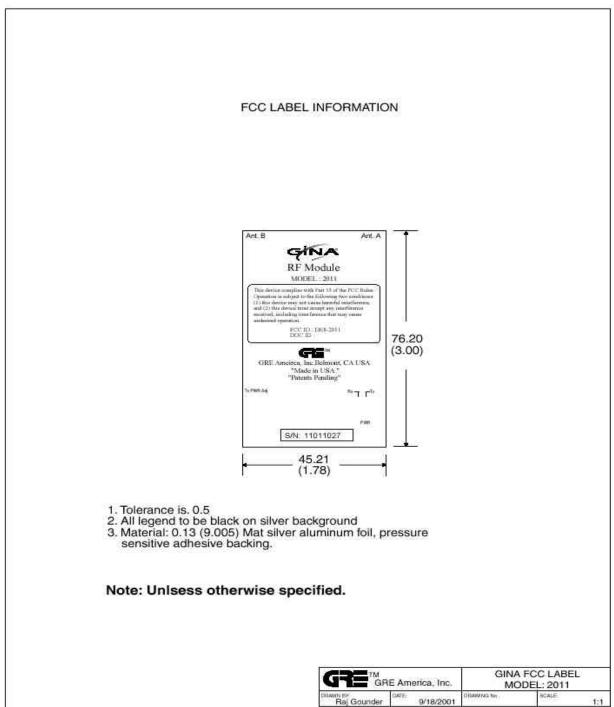




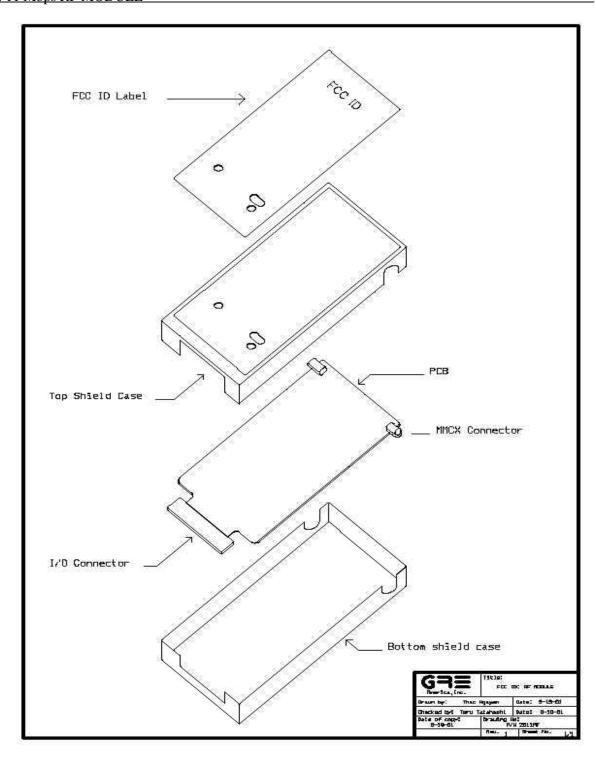


9/18/2001

PROPOSED FCC ID LABEL



Page 57 of 82



Page 58 of 82

DATE: OCTOBER 2, 2001

AGENT AUTHORIZATION LETTER

425 Harbor Blvd. GRE GRE AMERICA, INC. Tel: (650) 591-1400
Belmont, California 94002 Fax: (650) 591-2001

Agent Authorization Format (Federal Communications Commission)

Sept. 28, 2001

Federal Communications Commission Authorization and Evaluation Division Laboratory Division 7435 Oakland Mills Road Columbia, MD 21046

Gentleman:

We, the undersigned, hereby authorize Compliance Certification Services to act on our behalf in all matters relating to applications for equipment authorization, including the signing of all documents relating to these matters. Any and all acts carried out by COMPLIANCE certification Service on our behalf shall have the same effect as our own.

We also hereby certify that no party to the applications authorized hereunder is subject to a denial of benefits, that includes FCC benefits, pursuant to Section 5301 of the Anti-Drug Abuse Act of 1988, 21 U.S.C 853(a).

This agreement expires one year from the current date.

Sincerely.

Teru Takahashir
President

Page 59 of 82

DATE: OCTOBER 2, 2001

REQUEST FOR CONFIDENTIALITY

425 Harbor Blvd. GRE GRE AMERICA, INC.
Belmons, California 94002

Tel: (650) 591-1400 Fax: (650) 591-2001

Sept. 28, 2001

Federal Communications Commission Authorization and Evaluation Division Laboratory Division 7435 Oakland Mills Road Columbia, MD 21046

John LO.

Gentleman:

In accordance with the 0.459 CRF47 FCC Rules, GRE America requests confidentiality for the Block Diagram/ Schematics/Theory of Operation of the attached test reports.

These documents contain detailed system and equipment description and related information about the product, which we consider to be proprietary, confidential, and a custom design and otherwise, would not be released to the public. Since this design is a basis from which future technological products will evolve, GRE America feels that this information will be of benefit to its competitors, and that the disclosure of the information in these documents would give our competitors an unfair advantage in the markets.

Sincerety,

Teru Takahashi President

ANTENNA SPECIFICATION



ANTENNA GAIN & CABLE LOSS CALCULATIONS

The two antennas are constructed with a 10' or 13' coaxial cable and non-standard MMCX connector. Below we have calculated the total net gain with the cable loss.

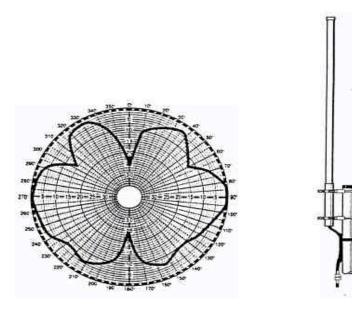
1. OMNIDIRECTIONAL ANTENNA CUSHCRAFT \$2403BP120

This antenna is constructed with a 10 ft. Ultralink cable Part number TL92463. The Connector and cable has a loss of 4.3 dB.

> = 3.0 dBdAntenna gain = 3.8 dBdCable loss Total gain = -0.8 dBdConnector loss = -0.5 dBd

> =-1.3 dBd Net gain = 0.84 dBiOr

Type Omni 2.404 to 2.478 GHz Frequency Gain 3 dBd Front to Back N/A Bandwidth, 1.5.1 100 MHz Beamwidth -3 dB 45° E-plane H-plane 360° Connector Type MMCX 13.5" Height Enclosure Material Fiberglass Weight 6 oz. Mount style Pipe clamp Max. Mast Diameter



2. DIRECTIONAL ANTENNA TELEX 2415

This antenna is constructed with a 13 ft. Ultralink cable Part number TL92463. Connector and cable for 13 ft is 4.3 dBd.

Antenna gain = 6.86 dBd Cable loss = -3.8 dBd Total gain = 3.06 dBd

Connector loss = -0.5 dBd Net gain = 2.56 dBd Or = 4.7 dBi

 Polarity
 Vertical or Horizontal

 Frequency
 2.404 to 2.478 GHz

 Gain
 9 dBi or 6.86 dBd

 Diameter
 3" x 18"

 Front to Back
 >20 dB

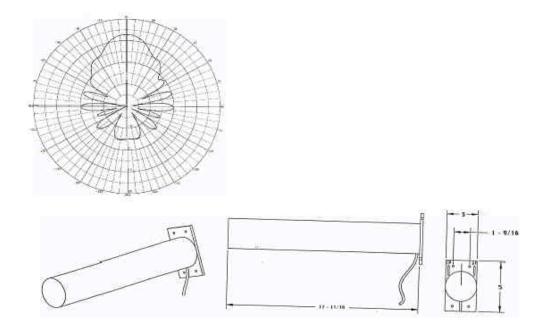
 SWR
 1.5.1 maximum

 Half Power Beamwidth
 30°

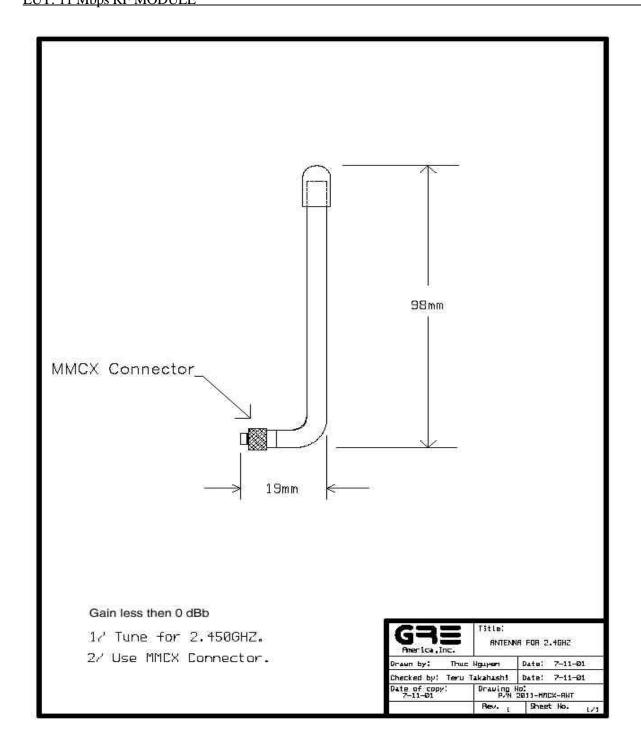
Nominal Impedance 50 ohms
Connector Type MMCX
Weight 25 oz

Mount U-Bolt Provided

Max. Mast Diameter 1.52 "



Page 63 of 82



Page 64 of 82

DATE: OCTOBER 2, 2001

USER'S MANUAL



Models: 2011 RF Module

User Manual



11 Mbps RF Module

"No more Wires"



Features

- Utilizing Intersil Prism II Technology
- 2.4 ~ 2.5 GHz ISM band operations
- Data rate up to 11 mbps
- Single heterodyne conversion
- Direct Sequence Spread Spectrum Technology
- +10 to +27 dBm transmitter power out
- Includes additional LNA for receiver front end.
- Diversity ANT for better receiver signal
- System targeting IEEE 802.11b standard except Tx power out. Set Tx power out as required by Application or per Country Regulation.
- Small size : 3.40" x 2.05" x 0.750" (86 x 52 x 19 mm).
- All Spec FCC part 15 ISM Band Non License compliant Radio.



Overview

The GINA-2011 is a small, versatile high performance RF Module that delivers data up to speeds of 11Mbits/s. The Module is designed to provide up to 0.5 watt (27dBm) output power. The GINA-2011 RF Module is available as a plug-in module for those Researche who wish to interface it with there own designed controllers.

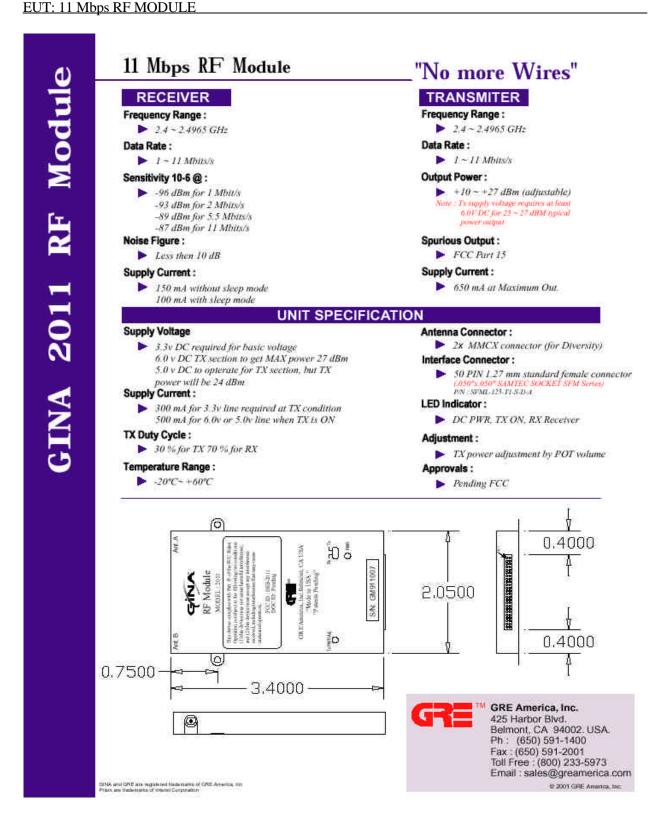
GINA-2011 operates at 2.4 GHz Direct Sequence Spread Spectrum (DSSS) Modulation physical layer can be compliant with IEEE 802.11b standard insures interoperability with other Wireless LAN products.

GINA-2011's highly integrated digital modulation transceiver module can also be used for factory automation equipment and barcode readers, embedded systems, and other applications.

APPLICATIONS

- Wireless Network
- Wireless Internet
- Mobile Scanner
- Remote Guidance Vehicles
- Robotic Remote Control
- Last-Mile Telephone
- Camera Surveillance Control (PTZ)
- Industrial Automation
- · GPS Data Link
- Power & Gas Utililies
- PLC / Router Connections
- Computer Data Links
- Traffic Controls
- Remote Networking
- High Speed File Transfer





Page 67 of 82

DATE: OCTOBER 2, 2001

Warning

WARNING

RADIATION.

RF energy at microwave frequencies is present with this equipment. Personnel should not be exposed to high RF energies, and should not be in front of the antenna when the equipment is switched on.

All accessible RF connections must be terminated when the radio is powered on.

The radio should not be powered on with any of its covers removed.

INFORMATION TO USERS.

"Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment."

1-1

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09/2001 rev.3

Page 68 of 82

GINA 2011 RF Module Voltage Requirement

GINA 2011 RF Module Voltage Requirement

The GINA 2011 RF Module requirs a device controller to set Local oscillator, Set BASEBAND processor for actual operating condition. It also requires proper I/O DC level because semiconductor is very thigh margin for I/O level.

The RF Module requires 3.3V and 6 Volt DC. Module has internal regulator to support 3.0V and 2.8 Volt. The device controller must be designed with 3 Volt working Voltage for I/O to RF Module. However it is not suitable if apply beyond 3.5V DC because majority of semiconductor Chip I/O level will be cross to Maximum specification point.

The 5 volt line is used for Transmitter final amplifier chip. The module 2011 has Current source voltage control MOS FET device to protect final amplifier chip. The final transmitter device is not liner output power verses voltage source. More likely the transmitter out is liner out with negative bias to GATE of Final amplifier. Nature of this performance comes from GaAs HFET parameter.

This negative bias to the GATE is regulated from 3.3volt line, so that transmitter out is set for Maximum to 27 dBm level.

However the 6 volt should not exceed more than 6 volt, due to some of the control line using 3 volt line to execute switching device.

Transmitter is not design to operate at 100% duty cycle.

Best performance is less than 30% duty cycle.

GINA 2011 RF Module is not designed or intended for any portable or handheld devices such as telephone set, PCMCIA devices or Portable PC's.

2-1

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GINA 2011 RF Module

Overview

Introduction

GINA RF Module 2011 is designed with the Prism II 11Mbit Intersil chipset to obtain a maximum performance data rate up to 11Mbit/sec. We are also focusing beyond the IEEE 802.11b application standard. The RF Module can provide an adjustable transmitter output power from 10 dBm to 27dBm (500 mW). The Receiver front end is installed with an extra low noise amplifier in order to perform extended distance wireless communications.

The RF Module size is also as small as a name card so as to cover any typical OEM application to fit this very small size. However this RF Module cannot work without a Controller. The Prism II chipset requires that you configure each registor value while programming from the other controller unit.

2. Requirement

GINA RF Module uses the Prism II chip set. The base band chip, RF up / down chip and the IF chip are required to be programmed from the Controller (similar to a MAC device). Therefore you should understand the basic theory about how it is necessary to program to these chips. The Data Book (included in this PDF downland Application Notes from Intersil) also describes a more detailed technical information on "How to Program".

Module are using chip as below.

HFA3861B-----Base band

HFA3783N-----IF

HFA3683AIN-----RF up/down

- 2a The RF Module requires the User to basically enable the transmit or receive mode via the controller unit. You must also select the antenna port because the RF Module features a dual antenna port for diversity operations. This selection is executed via the base band chip HFA3861.
- 2b DC voltage required to module.

3.3 v DCmax current 300mA

6.0v DC -----max current 650 mA

(5.0 VDC still will operate however the Tx out power will be at 24 dBm maximum)

Programming

2c Please be sure to follow these requirements when you are

programming the RF Module.

Master clock ------44.000 Mhz

IF center frequency -----374 Mhz

Therefor 1st LO frequency need to program to HFA3683AIN RF up/down chip.

LO = Frx/tx - 374 Mhz Frx/tx is receive or transmit frequency between 2400~2500 Mhz.

2d Also IF chip HFA 3783IN need to program .

Main clock -----44.000 Mhz

LO required to program -----2 x 374 Mhz which is 748 Mhz.

3-1

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2e Base band chip HFA 3861B must also be programmed. However this program will be up to the design of your system. You should be familiar with and understand the HFA 3861B programming requirement. Main clock is 44,000 MHz

PIN Description

RF Module PINOUTS H=3v L=.5v or less O = out put from Module I = input to Module					
PIN No.	PIN Name	Type	DESCRIPTION		
î	TR_SW_N	i.	Control antenna switch.H for RX. L for TX on.		
2	RADIO_PD	i.	Enable VCO. Normally set to H		
3	LE_RF	Programming HFA3683 (pin21) for PLL latch e			
4	GND				
5	GND				
6	GND				
7	S_DATA 1		Programming HFA3861B(pin 3,64 internally connected)		
9 TX_CLK O TX clock from HFA3 10 TX_RDY O Output from HFA38		0	Recovered RX data from HFA3861(pin53)		
		0	TX clock from HFA3861 (pin 55) to controller		
		0	Output from HFA3861(pin 59)for other device HFA3861(pin 61)receiver enable active H		
		1.			
12	NOT USE				
13	NOT USE	j			
14	NOT USE				
15	vccs	I.	HFA3861 digital voltage(pin2,8,37,41,57) 3.3V required		
16	NOT USE				
17	3,3v	T.	Supply voltage to Module current will up to 300 ma		
18	3,3v	T.	Same as above		
19	3.3v	1	Same as above		
20	NOT USE	ĺ			
21	NOT USE	į			
22	CAL_EN	F.	Controlled HFA3783(pin42)		
23	LE_IF	F	HFA3783(pin20) PLL latch enable		

3-2

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	H=3v L=	5v or l	RF Module PINOUTS ess O = out put from Module I = input to Module	
24	PA_PE	10	Enable TX amplifier .normally set to H	
25 6.0v		10	Using TX final AMP stage and RX LNA.It is require 650mA current when TX is on.20mA for RX is on.	
26	TR_SW	10	Control antenna switch H for TX. L for Receive.	
27	PEI	10	power enable control for HFA 3783,3683(PE1 pin)	
28	PE2	1	power enable control for HFA 3783,3683(PE2 pin)	
29	SCLK_RF_IF	10	clock to program PLL for HFA3783(pin18)3683(pin23)	
30	SD_RF_IF	10	data to program PLL for HFA3783(pin19) ,3863(pin22)	
31	NOT USE			
32	RX_CLK	0	Receive clock out from HFA3861 (pin52)	
33	MD_RDY	0	Data packet ready from HFA3861 (pin54)	
34	TX_DATA	10	Transmit data to HFA3861 (pin58)	
35	CCA	0	Clear Channel Assessment out from HFA3861(pin60)	
36	TX_PE	10	HFA3861(pin62) transmitter control, Active H	
37	RESET_BB	10	Reset for HFA3861(pin63)	
38	NOT USE	P		
39	S_CLK	E	Clock for programming HFA3861(pin4)	
40	BB_R/W	L	Input to HFA3861(pin5) for programming	
41:	CS_BB	L	Chip select input to HFA3861(pin6) for programming	
42	NOT USE			
43	NOT USE			
44	NOT USE			
45	NOT USE			
46	NOT USE			
47	NOT USE			
48	NOT USE			
49	6.0v	T.	Same voltage as pin 25	
50	6.0v	T.	Same voltage as pin 25	

3-3

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Connector Layout



LED Indicator

3 LED indicator

Module has 3 different LED located inside of shield case,

Power on RED color LED

TX on RED color LED

RX condition by GREEN color LED .----sharing CCA output from HFA3861,

4 Antenna connector

Module has two antenna connector located on right side and left side.

Marked "A" on Right side

Marked "B" on Left side

NOTE: You can program and select A or B by HFA3861B CR9 and CR40. This will depend upon how you elect to configure your system either for a single antenna or diversity antenna.

5 Technical information

GRE America Inc. cannot provide any schematic diagram (s) or component (s) specifications for any Customers / End Users for any reasons. GRE America will however provide a Block Diagram for reference and in oder to familiarize you with the RF Module.

3-4

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DOCUMENT NO: CCSUP4031A TEL: (408) 463-0885 FAX: (408) 463-0888

This report shall not be reproduced except in full, without the written approval of CCS. This document may be altered or revised by Compliance Certification Services personnel only, and shall be noted in the revision section of the document.

GINA Warranty

DATE: OCTOBER 2, 2001

Warranty

Limited Warranty

General

GRE America, Inc. warrants all parts of each new product to be of sound design, good material and workmanship, and will repair or exchange any parts proven to be defective under normal use at no charge for a period of 12 months from the date of sale to the end user.

Defects will be corrected by GRE America, There will be no charge for labor for a period of 12 months from the date of original sale, except as provided below. Overtime premiums and/or expedited handling and shipping costs must be paid by the owner.

Warranty Limitations

This warranty does not apply to equipment or parts that have been subject to accident, abuse, incorrect service, alterations, service by non-authorized service personnel, misuse, or on units upon which the warranty seal has been removed, altered, or mutilated.

A copy of the warranty certificate or purchase receipt must be supplied to GRE America when requesting service.

Equipment must be sent to GRE America at the owner's expense and will be returned via surface carrier at no cost to the owner.

This warranty is strictly limited to the terms indicated herein, and no other warranties or remedies thereunder, express or implied, shall be binding on GRE America.

Contact

GRE America, Inc 425 Harbor Blvd. Belmont, CA 94002. USA PH: (650) 591-1400

Fax: (650) 591-2001

Sales e-mail: sales@greamerica.com Support e-mail: support@greamerica.com Website: http://www.greamerica.com

3-1

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1/01

PART LIST

GRE AMERICA PROPRIETARY

			Circuit function	of the device discription	
				RF MODULE	
				11 FCC ID:DE8-2011	
ECN# REVISE DATE PER	MED: 1/22	9/28/01 9/28/01	Model 20	III FGC 10-DE0-2011	
ITEM	TOTAL	MANUFACTURER P/N	MANUFACTURER	PART DISCRIPTION	PART LOCATION
Ť:	1	HFA3861B	INTERSIL	BASE BAND CHIP	UI:
2	- 1	HFA3783IN	INTERSIL	IF CHIP	ti2
3	1	HFA3683AIN	INTERSIL	UP/BOWN CHIP:	U3:
4	- 1	HFA3983IV	INTERSIL	TX PWR AMP	U9
- 6	- 1	DMP-VCX74896	DELTA	VOO	U4-
0	1	DMP-VCX204796	DELTA	VOO	uš
7.	4	MIC5205-2.8BM5	MICREL	2.8V.REG	U15
8.	1	MI05205-3 0BM5	MICREL	3.0V REG	LI6
9	2	HMC174MSB	HITTITE	AN7 SW	U7.#
10:	10	ICL7660CBA	MAXIM	NEG REG	uio
11	1	SHF-0589	STANFORD	EET TX AMP	U11
12	1	RF1K49093	INTERSIL	MOS FET	U12
13	1	HMC286	HITTITE	LOW NOISE AMP	013
14	- 1	EC2645TX-44-00	ECLIPTÉK.	44 MHZ OSC	014
15	2	SML LX1206IC-TR	LUMEX	RED LED	LED2.3
16	1	SML LX1206GC TR	LUMEX -	GREEN LED	LED1
17	1	SAWTECHB55653	SAWTECH	FILTER	FL1
16.	3	LFJ30 03824429084	MURATA	2.4GHZ FILTER	FL256.
19	1	TDFM1B:2450T-10	1000	2 AGHZ FILTER	FL4
20	2	MGSF1N02LT / IRLML2402TR	MOTOROLA / IR	FET	01.5
21	1	MGSF1PO2LT //RLML6302TR	MOTOROLA / IR	FET	Q2
22	3	290 3365 EV	TOSHIBA	TRANSISTOR	03.4,6
23	.5	EXIC ML20A390U	PANASONIC	BEAD CORES SIZE 805	1.1.11.12.16.17
24	3	ELJ-RELN5ZF2	PANASONIC	CHIP INDUCTOR: 1 5nH (SIZE 603)	LS,9.10
26	1	ELJ-REBN3ZF2	PANASONIC	CHIP INDUCTOR 3.3nH (603)	£13
25	д	ELJ-RE6N8ZF2	PANASONIC	CHIP INDUCTOR 6.86H	L15.19.20.21
26	1	ELI-RELBNGF2	PANASONIC	CHIP INDUCTOR 18nH(SIZ 603)	44

PAGE 1 OF 3

GRE AMERICA PROPRIETARY

27	4	ELI-RE39NGF2	PANASONIC	CHIP INDUCTOR 33nH(SIZE 603)	12,3,6.7
28	2	ELI-RE39NGF3	PANASONIC	CHIP INDUCTOR 39nH(SIZE 603)	£5.14
29:	1	ELI-RER22JF3	PANASONIC	CHIP INDUCTOR 220nH (0603)	118
30.	- 1	2900107X901002T	SPRAGUE/VISHEY	CHIP TANT CAP 100UF/10V	C65
31	1	ECJ:1VB03474K	PANASONIC	CHIP CAP . 47uF(SIZE 603)	C108
32	10	2930106X90208	SPRAGUE/VISHEY	CHIP TANT CAP 10uF/10V	C1.3.27.36.38.47.112.105.106.145
33	1	ECJ 1VB03684K	PANASONIC	CHIP CAP :68uF(\$12E (603)	C70
34	27	CLIGBIO4KONC	SAMSUNG	CHIP CAP TUF (SIZE 603)	C2.4,5.6,10,11,13,16,17,18,19,20,22,31
			9	0.000	32,35,37,39,46,48,49,51,62,67
			2.22230022	W. H. STATES AND STATE	.72,75,83
35	12	CL10B103KBNC	SAMSUNG	CHIP CAP DILIF (SIZE 603)	C7.9.50,52.53,58,61.63,64,66,69,102
36	12	MCH185C102KK	ROHM	CHIP CAP .001uF (SIZE 603)	C15,33,34,74,78,100,101,103,104,92
18		55-			116,122
37	10	CL108223KANC	SAMSUNG	CHIP CAP 022uF(SIZE 603)	024
36.	1	\$860W689K1HRN	RGA.	CHIP CAP .068µF	C71
39	1	ECJ-1VB1A224K	PANASONIC	CHIP CAP 22uF	C25
40.	8.	140-CC504N1 0C	XICON	CHIP CAP 1PF (SIZE 603)	C94.97.98.110.111.130.147.176
41	8	CEORSCINO	MARUWA	CHIP CAP 0 SPF(BIZE 609)	C8.89 126 129 132;144;148;149
42	3	CE020C1NO	MARUWA	CHIP CAP 2PF (SIZE 605)	C26,93,109
43	4	MCH185AC3GCK	ROHM	CHIP CAP 3PF (SIZE 603)	C134
44	6	MCH185A050CK	ROHM	CHIP CAP SPF(SIZE 603)	054,57,59,124,133,138
45	12	MCH185A070DK	ROHM	CHIP CAP 7PF(SIZE 603)	C41,42,43,44,45,55,77,95,117,118,135
					143
48	2	MCH185A100DW	MHOR	CHIP CAP 10PF (SIZE 603)	C81.92
47	9	MCH185A220JK	ROHM	CHIP CAP 229F(SIZE 603)	C84.85,96,120,123,136,137,141,146
48.	- 1	MCH185A390JK	RDHM	CHIP CAP 33PF(SIZE 603)	C90
49	1	MCH185A6901K	ROHM	CHIP CAP 68PF (SIZE 603)	C28
50	12	MCH185A101JK	ROHM	CHIP CAP 100PF(SIZE 603)	012,21,23,29,30,73,107,114,115
7		5		E	119,127,128
51	1	MCHI85AI51JK	ROHM	CHIP CAP 150PF (SIZE 603)	040
52	16	CE221 FING	MARUWA	CHIP CAP 220PF (SIZE 603)	C56,60;68,79,80,86,87,139,140,142
53	1	CE271J1NO	MARUWA	CHIP CAP 270PF(SIZE 603)	C98
54	1	J2060	VOLTRONICS	TRIMMER CAP 6PF	C125
55	1	RC1608J000CS	SAMSUNG	O OHM CHIP REGISTOR(SIZE 603)	R70
55.	2	RC1608J100CS	SAMSUNG	10 OHM CHIP RES (SIZE 603)	R46,47
57	1	RC16081220CS	SAMSUNG	22 OHM CHIP RES (SIZE 603)	R63
.58.	2	MCR09J330	MHOR	33 OHM CHIP RES (SIZE 603)	942.50
59	-1	MCR03J390	ROHM	39 OHM CHIP RES (SIZE 603)	810

PAGE 2 OF 3

GRE AMERICA PROPRIETARY

\rightarrow			24	1	
95	1	GR d 3 5	FIJIPOLY	HEAT SINC PAD35X15x3.5mm	
94	- 1		GREA	MODEL&FCC LABEL	
92	1	2011-3	ICPC	PCB	
91	1	SPML 125 T1-S-D-A	SAMTED	50 PIN C/F CONNECTOR	
90	1	0	EM)	ARC SHIELD YT-721-1-24	
89	-1		GREA	SHIELD CASE	
88	. 2	135,3711.901	JOHNSON	SMD RF CONNECTOR MMCX	8
67	1	ST3A501	E C COMP	500 OHM POT SMD	VR1
86	- 2	9006031A1912FKHFT	PHYCOMP	19.1 KOHM CHIP RES (SIZE 603)	R21,20
85	1	9C06031A1212FKRFT	PHYCOMP	12 1 KOHM CHIP RES (SIZE 603)	R22
84	_1_	9006031A1152FKRFT	PHYCOMP	11.5 KOHM CHIP RES (SIZE 603)	R4
83	- 1	RM73B1J103J	KOA	10 KOHM CHIP RES (SIZE 603)	R16
82	- 1	RC1608F9531CS	SAMBUNG	9.53 KOHM CHIP RES (SIZE 603)	R6
81	4	9C06O31A470.ILHFT	PHYCOMP	4.7 KOHM CHIP RES (SIZE 603)	R59.54.61.62
80	1	RC1608F4021CS	SAMSUNG	4.02 KOHM CHIP RES (SIZE 603)	R65
79	2	RM7381J332J	KOA	3.2 KOHM CHIP RES (SIZE 603)	R45.49
78	. 1	RM73B1J202J	XGA	2 KOHM CHIP RES (GIZE 603)	R44
77	. 2	RM73B1./152J	KOA	1.5 KCHM CHIF RES (SIZE 603)	R5.12
76	1	RM73B1J22J	KGA .	1 2KOHM CHIP RES (SIZE 603)	R71
75	- 11	RM73B131023	K.OA	I KOHM CHIP RES (SIZE 603)	R3.7,8.15,27,36,40,51,72,73,74
74	- 1	9C06031A82G0JLHFT	PHYCOMP	820 OHM CHIP RES (SIZE 603)	R38
73	2	9C06031A68003LHFT	PHYCOMP	680 OHM CHIP RES (SIZE 603)	R11.14
72	- 1	ER///IGSY/561	PANASONIC	560 OHM CHIP RES (SIZE 503)	R13
7.1	- 2	9C06031A5360FKHFT	PHYCOMP	536 OHM OHIP RES (SIZE 603)	R25.31
69	- 3	P006031A3900JLHFT	PHYCOMP	390 OHM CHIP RES (SIZE 603)	R55,64,69
68	1	ERJ/3GSYJ331	PANASONIC	330 OHM CHIP RES (SIZE 603)	R52
67	2	CRGW0603-271JRT1	DALE	270 OHM CHIP RES (SIZE 609)	R67.68
65	- 4	9C06031A1800JLHFT	PHYCOMP	180 OHM CHIP RES (SIZE 603)	R1.2.56.57
64	3	RC1608F1500CS	SAMBUNG	150 OHM CHIP RES (SIZE 603)	R37,39,41
63	- 4	9C06031A1240FHHT	PHYCOMP	124 DHM CHIP RES (SIZE 603)	R23;24,29.30
62	- 37.	RM73B131013	KOA	100 OHW CHIP RES (SIZE 609)	R33,34,43,45,58,66,75
61	4	ERJ/3GSYJB60	PANASONIC	56 OHM CHIP HES 10609	Ratii
50	. 1	RC1608F49R9CS	SAMSUNG	49.9 OHM CHIP RES (SIZE 603)	R35

PAGE 3 OF 3

PRODUCT SPECIFICATION

11 Mbps RF Module

"No more Wires"



Features

- Utilizing Intersil Prism II Technology
- 2.4 2.5 GHz ISM band operations
- · Data rate up to 11 mbps
- · Single heterodyne conversion
- Direct Sequence Spread Spectrum Technology
- +10 to +27 dBm transmitter power out
- Includes additional LNA for receiver front end.
- Diversity ANT for better receiver signal
- System targeting IEEE 802.11b standard except Tx power out. Set Tx power out as required by Application or per Country Regulation.
- Small size : 3.40" x 2.05" x 0.750" (86 x 52 x 19 mm).
- All Spec FCC part 15 ISM Band Non License compliant



Overview

The GINA-2011 is a small, versatile high performance RF Module that delivers data up to speeds of 11Mbits/s. The Module is designed to provide up to 0.5 watt (27dBm) output power. The GINA-2011 RF Module is available as a plug-in module for those Researche who wish to interface it with there own designed controllers.

GINA-2011 operates at 2.4 GHz Direct Sequence Spread Spectrum (DSSS) Modulation physical layer can be compliant with IEEE 802.11b standard insures interoperability with other Wireless LAN products.

GINA-2011's highly integrated digital modulation transceiver module can also be used for factory automation equipment and barcode readers, embedded systems, and other applications.

APPLICATIONS

- Wireless Network
- Wireless Internet
- Mobile Scanner
- Remote Guidance Vehicles
- Robotic Remote Control
- Last-Mile Telephone
- Camera Surveillance Control (PTZ)
- Industrial Automation
- GPS Data Link
- Power & Gas Utililies
- PLC / Router Connections
- Computer Data Links
- Traffic Controls
- Remote Networking
- High Speed File Transfer



DATE: OCTOBER 2, 2001

11 Mbps RF Module "No more Wires" RECEIVER TRANSMITER Frequency Range: Frequency Range: 2.4 ~ 2.4965 GHz 2.4 ~ 2.4965 GHz Data Rate: Data Rate : I ~ 11 Mbits/s ► 1 ~ 11 Mbits/s Output Power: Sensitivity 10-6 @: ► +10 ~ +27 dBm (adjustable) -96 dBm for 1 Mbit/s -93 dBm for 2 Mbits/s Note: Tx supply voltage requires at leas 6.0V DC for 25 ~ 27 dBM typical -89 dBm for 5.5 Mbits/s -87 dBm for 11 Mbits/s Spurious Output: Noise Figure: FCC Part 15 Less then 10 dB Supply Current: Supply Current: ► 650 mA at Maximum Out. ▶ 150 mA without sleep mode 100 mA with sleep mode UNIT SPECIFICATION Supply Voltage Antenna Connector: 2x MMCX connector (for Diversity) 3.3v DC required for basic voltage 6.0 v DC TX section to get MAX power 27 dBm Interface Connector: 5.0 v DC to opterate for TX section, but TX ▶ 50 PIN 1.27 mm standard female connector power will be 24 dBm PAN : SFME-125-T1-S-D-A Supply Current: LED Indicator: > 300 mA for 3.3v line required at TX condition DC PWR, TX ON, RX Receiver 500 mA for 6.0v or 5.0v line when TX is ON TX Duty Cycle: Adjustment: 30 % for TX 70 % for RX ➤ TX power adjustment by POT volume Temperature Range: Approvals: -20°C~+60°C ▶ Pending FCC 0.4000 00 GM911007 2,0500 0.4000 0 0.75003.4000 GRE America, Inc. 425 Harbor Bivd. Belmont, CA 94002, USA. Ph: (650) 591-1400 Fax: (650) 591-2001 Toll Free: (800) 233-5973 Email: sales@greamerica.com SIMA and SRE are registered insternants of ORE America. The Fifter, are trademarks of miscell Corporation. to 2001 GRE America, Inc.

Page 79 of 82

PROCESSING GAIN

THEORY OF OPERATION

RF BLOCK DIAGRAM & SCHEMATIC DIAGRAM